Schottky Dual Diode

PBYR1040CT

40V / 10A

DATASHEET

OEM – Philips

Source: Philips Databook 1999

Datasheet Rev. 1.3 – 04/19 – data without warranty / liability

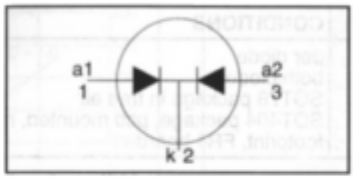
Rectifier diodes Schottky barrier

PBYR1545CT, PBYR1545CTB series

FEATURES

- Low forward volt drop
- Fast switching
- Reverse surge capability
- High thermal cycling performance
- Low thermal resistance

SYMBOL



QUICK REFERENCE DATA

V_R = 40 V/ 45 V

$I_{O(AV)}$ = 15 A

$V_F \leq 0.57$ V

GENERAL DESCRIPTION

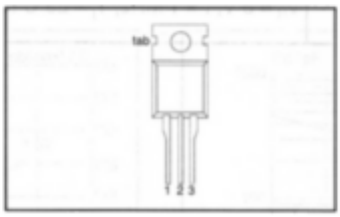
Dual, common cathode schottky rectifier diodes in a conventional leaded plastic package and a surface mounting plastic package. Intended for use as output rectifiers in low voltage, high frequency switched mode power supplies.

The PBYR1545CT series is supplied in the SOT78 conventional leaded package.
The PBYR1545CTB series is supplied in the SOT404 surface mounting package.

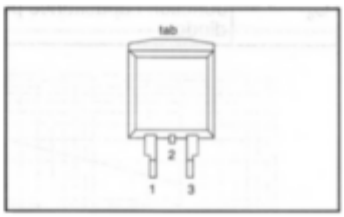
PINNING

PIN	DESCRIPTION
1	anode 1 (a)
2	cathode (k) [1]
3	anode 2 (a)
tab	cathode (k)

SOT78 (TO220AB)



SOT404



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT
		PBYR15 PBYR15		40CT 40CTB	45CT 45CTB	
V_{RRM}	Peak repetitive reverse voltage		-	40	45	V
V_{RWM}	Working peak reverse voltage		-	40	45	V
V_R	Continuous reverse voltage	$T_{mb} \leq 107$ ˚C	-	40	45	V
$I_{O(AV)}$	Average rectified forward current (both diodes conducting)	square wave; $\delta = 0.5$; $T_{mb} \leq 128$ ˚C	-	15		A
I_{FRM}	Repetitive peak forward current (per diode)	square wave; $\delta = 0.5$; $T_{mb} \leq 128$ ˚C	-	15		A
I_{FSM}	Non-repetitive peak forward current per diode	t = 10 ms	-	135		A
		t = 8.3 ms	-	150		A
		sinusoidal; $T_j = 125$ ˚C prior to surge; with reapplied $V_{RRM(max)}$				
I_{RRM}	Peak repetitive reverse surge current per diode	pulse width and repetition rate limited by $T_{j\,max}$	-	1		A
T_j	Operating junction temperature		-	150		˚C
T_{stg}	Storage temperature		- 65	175		˚C

1. It is not possible to make connection to pin 2 of the SOT404 package.

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j-mb}$	Thermal resistance junction to mounting base	per diode	-	-	3	K/W
		both diodes	-	-	2	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient	SOT78 package in free air	-	60	-	K/W
		SOT404 package, pcb mounted, minimum footprint, FR4 board	-	50	-	K/W

ELECTRICAL CHARACTERISTICS

T_j = 25 ˚C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_F	Forward voltage per diode	I_F = 7.5 A; T_j = 125˚C	-	0.44	0.57	V
		I_F = 15 A; T_j = 125˚C	-	0.63	0.72	V
		I_F = 15 A	-	0.62	0.84	V
I_R	Reverse current per diode	$V_R = V_{RWM}$	-	0.22	1	mA
		$V_R = V_{RWM}$; T_j = 100˚C	-	18	25	mA
C_d	Junction capacitance per diode	V_R = 5 V; f = 1 MHz, T_j = 25˚C to 125˚C	-	270	-	pF

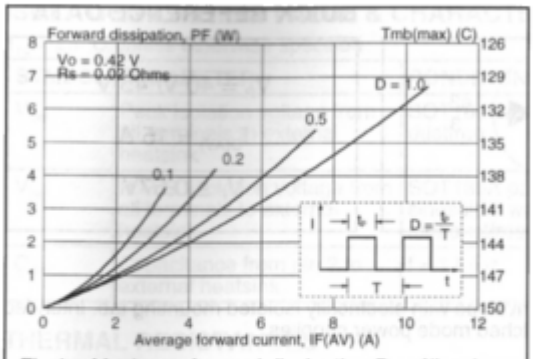


Fig.1. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; square current waveform where $I_{F(AV)} = I_{F(RMS)} \times \sqrt{D}$.

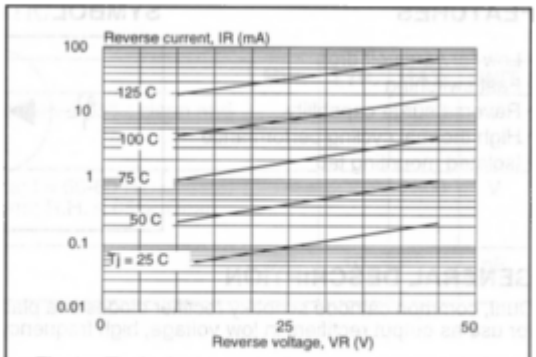


Fig.4. Typical reverse leakage current per diode; $I_R = f(V_R)$; parameter T_j

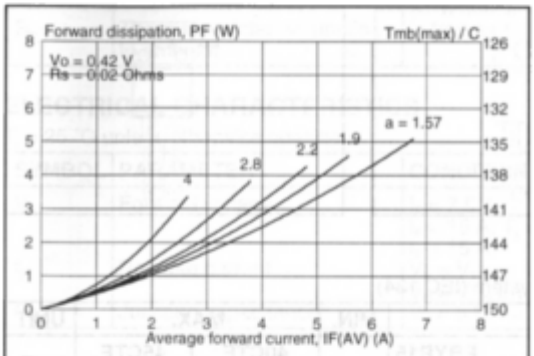


Fig.2. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; sinusoidal current waveform where a = form factor = $I_{F(RMS)} / I_{F(AV)}$.

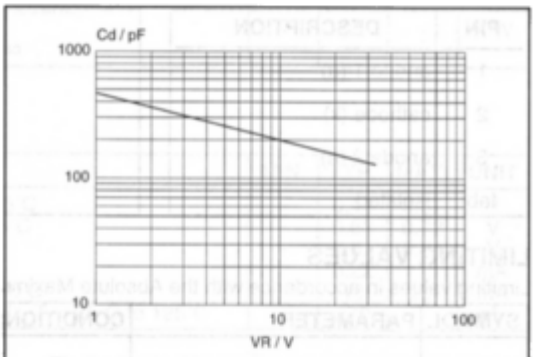


Fig.5. Typical junction capacitance per diode; $C_d = f(V_R)$; f = 1 MHz; T_j = 25˚C to 125 ˚C.

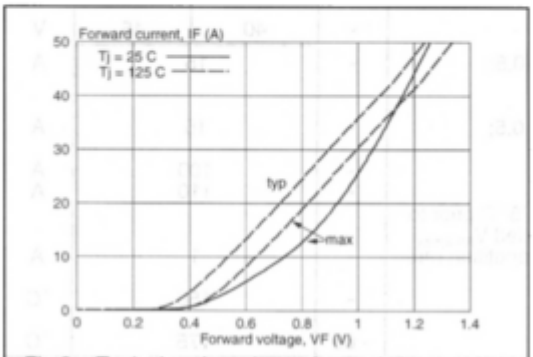


Fig.3. Typical and maximum forward characteristic $I_F = f(V_F)$; parameter T_j

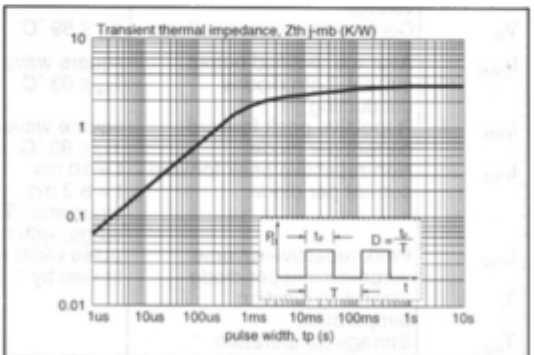


Fig.6. Transient thermal impedance per diode; $Z_{th\ j\text{-}mb} = f(t_p)$.